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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Hiroshi Otori
Takesada Akiba
Goro KitsukawaAdditional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____

Execution Date: December 23, 1996

2. Name and address of receiving party(ies)

Name: Hitachi Ltd.

Internal Address: _____

New Marunouchi Building

Street Address: 5-1 Marunouchi 1-chome, Chiyoda-ku

City: Tokyo, Japan State: _____ Zip: 100

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application No.(s) _____

B. Patent No.(s) 5,859,807

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: David M. O'Dell

Internal Address: Haynes and Boone, LLP

Street Address: 901 Main Street, Suite 3100

City: Dallas State: TX Zip: 75202

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41).....\$ 40.00

☒ Enclosed☒ Authorized to be charged to deposit account

8. Deposit account number:

08-1394

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9. Signature.

David M. O'Dell, #42,044

Name of Person Signing

Signature

2-2-04

Date

Total number of pages including cover sheet, attachments, and documents: 2

02/09/2004 HGETACHE 00000003 5859807

Mail documents to be recorded with required cover sheet information to:

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PATENT
REEL: 014953 FRAME: 0228

70608 U.S. PTO

08/847350



04/24/97

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made and filed herewith; and

WHEREAS, HITACHI LTD., of Japan, with its principal office at the New Marunouchi Building, 5-1 Marunouchi 1-chome, Chiyoda-ku, Tokyo 100, JAPAN, is desirous of acquiring my entire right, title and interest in and to the invention, and to the application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to HITACHI LTD., its successors and assigns, my entire right, title and interest in and to the invention and in to the application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to HITACHI LTD., as assignee of my entire right, title and interest.

I also hereby sell and assign to HITACHI LTD., its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to HITACHI LTD., or to its successors, assigns, and legal representatives, any facts know to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawfully papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid HITACHI LTD., its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year:

TITLE OF INVENTION	SEMICONDUCTOR INTEGRATED CIRCUIT DEVICE HAVING A CONTROLLED OVERDRIVING CIRCUIT	
INVENTOR SIGNATURE AND DATE	Hiroshi Otori <i>Hiroshi Otori</i>	Dec 23, 1996 Date
INVENTOR SIGNATURE AND DATE	Takesada Akiba <i>Takesada Akiba</i>	Dec. 23, 1996 Date
INVENTOR SIGNATURE AND DATE	Goro Kitsukawa <i>Goro Kitsukawa</i>	Dec. 23, 1996 Date
RESIDENCE (City, State)	all of Tokyo, Japan	

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